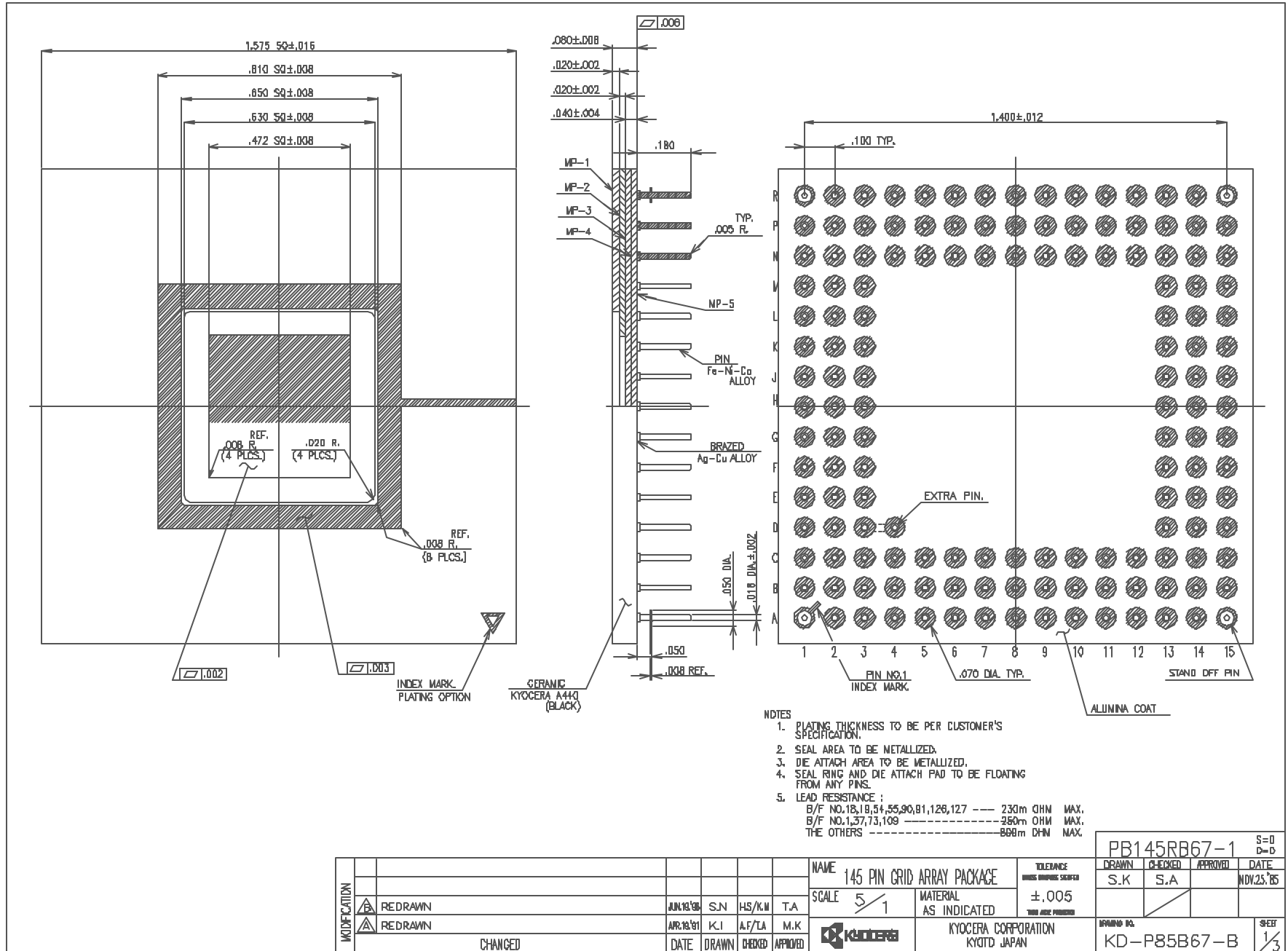
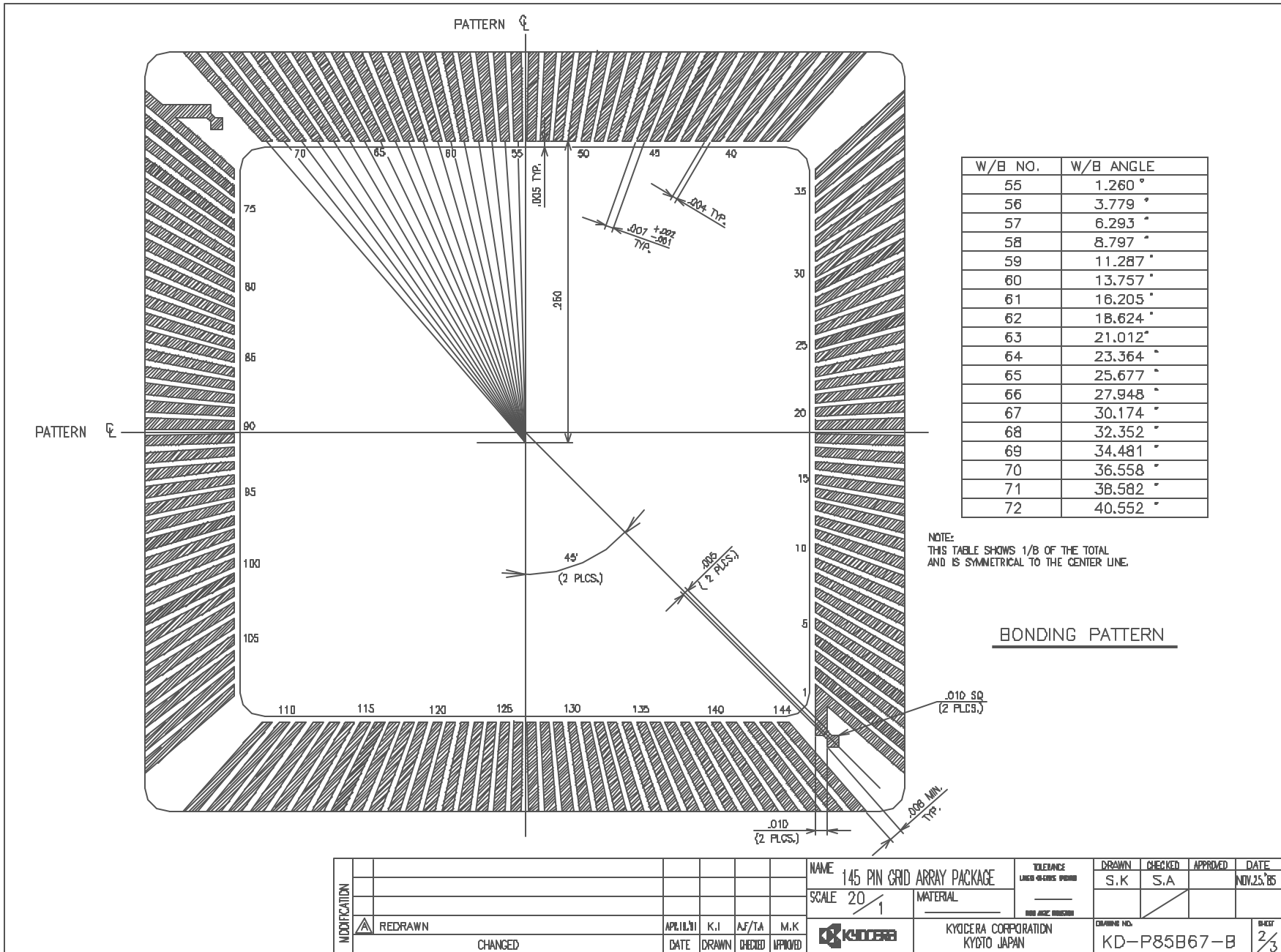



SSM P/N CPG14435



SSM P/N CPG14435



MODIFICATION					NAME	145 PIN GRID ARRAY PACKAGE	TOLENANCE	DRAWN	CHECKED	APPROVED	DATE
	REDRAWN	CHANGED	APR/11/01	K.J.	A.F./T.A.	M.K.	LINES & DIMS POINTS	S.K.	S.A.		NOV.25.'05
			DATE	DRAWN	CHECKED	APPROVED					
						KYOCERA CORPORATION KYOTO JAPAN		DRAWING NO.		SHEET	
								KD-P85B67-B		2/3	



WIRE BOND PAD / CONNECTOR PIN INTERCONNECTION PLAN

W/B NO.	PIN NO.	W/B NO.	PIN NO.	W/B NO.	PIN NO.	W/B NO.	PIN NO.	W/B NO.	PIN NO.	W/B NO.	PIN NO.
1	D3	27	M1	53	R8	79	L14	105	D13	131	B6
2	C2	28	N1	54	N8	80	M15	106	C13	132	C6
3	B1	29	M2	55	N9	81	K13	107	B14	133	A5
4	D2	30	L3	56	R9	82	K14	108	A15	134	B5
5	E3	31	N2	57	R10	83	L15	109	C12	135	A4
6	C1	32	P1	58	P9	84	J14	110	B13	136	A3
7	E2	33	M3	59	P10	85	J13	111	A14	137	B4
8	D1	34	N3	60	N10	86	K15	112	B12	138	C5
9	F3	35	P2	61	R11	87	J15	113	C11	139	B3
10	F2	36	R1	62	P11	88	H14	114	A13	140	A2
11	E1	37	N4	63	R12	89	H15	115	B11	141	C4
12	G2	38	P3	64	R13	90	H13	116	A12	142	C3
13	G3	39	R2	65	P12	91	G13	117	C10	143	B2
14	F1	40	P4	66	N11	92	G15	118	B10	144	A1
15	G1	41	N5	67	P13	93	F15	119	A11		
16	H2	42	R3	68	R14	94	G14	120	B9	S/R	NC
17	H1	43	P5	69	N12	95	F14	121	C9	D/A	NC
18	H3	44	R4	70	N13	96	F13	122	A10	EXTRA PIN (D4)	D3
19	J3	45	N6	71	P14	97	E15	123	A9		
20	J1	46	P6	72	R15	98	E14	124	B8		
21	K1	47	R5	73	M13	99	D15	125	AB		
22	J2	48	P7	74	N14	100	C15	126	CB		
23	K2	49	N7	75	P15	101	D14	127	C7		
24	K3	50	R6	76	M14	102	E13	128	A7		
25	L1	51	R7	77	L13	103	C14	129	A6		
26	L2	52	P8	78	N15	104	B15	130	B7		

MODIFICATION						NAME	145 PIN GRID ARRAY PACKAGE	TOLERANCE	±0.03 (UNLESS SPECIFIED)	DRAWN	CHECKED	APPROVED	DATE
						SCALE	×	MATERIAL		S.K	S.A		NOV.25, '85
	△	REDRAWN						THIS WIRE PADDED					
	CHANGED	APR.18/91	K.I	AF/TA	M.K		KYOCERA CORPORATION KYOTO JAPAN			DRAWING NO.	KD-P85B67-B		HEET 3/3
		DATE	DRAWN	CHECKED	APPROVED								

